SY28637E

Single-Channel, Adjustable Voltage Monitor in an Ultra-Small Package

General Description

The SY28637E is a compact supervisory circuit that monitors voltages greater than 500mV with 1% threshold accuracy. The output assertion delay time can be adjusted using an external capacitor. The device features a logic high enable pin to control the power on and off the internal logic.

Operating within a voltage range of 1.7V to 6.5V, the SY28637E has a typical quiescent current of 9μA and an open-drain output rated at 18V.

The device is available in an ultra-small DFN 1.45mm×1.0mm–6pin package and is fully specified for operation over a temperature range of T_J=-40°C to 125°C.

Features

- Operating Voltage Range: 1.7V to 6.5V
- Adjustable Threshold Down to 500mV
- Threshold Accuracy: 1% Over Temperature
- Capacitor-Adjustable Delay Time
- Low Quiescent Current: 9μA (typ.)
- Open Drain Output (Rated at 18V)
- Temperature Range: -40°C to 125°C
- RoHS Compliant and Halogen Free
- Compact Package: DFN1.45×1-6

Applications

- Notebook and Desktop Computers
- Microcontrollers, DSPs, and Microprocessors
- Portable and Battery-Powered Products
- FPGAs and ASICs

Typical Application

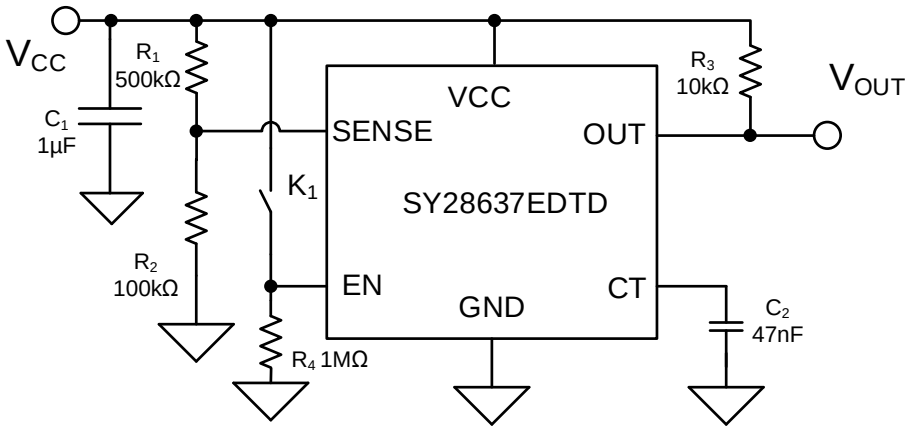


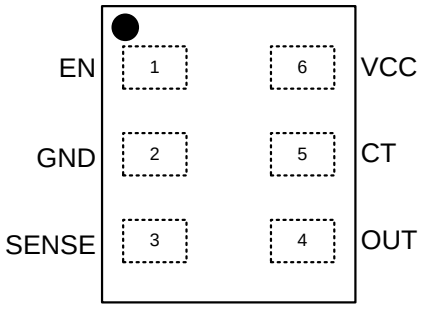
Figure 1. Schematic Diagram

Ordering Information

Ordering Number	Package Type	Top Mark
SY28637EDTD	DFN1.45×1-6 RoHS Compliant and Halogen Free	**b*xyz***

Device code: b
x=year code, y=week code, z= lot number code

Pinout (Top View)



(DFN1.45×1-6)

Pin Name	Pin Number	I/O	Pin Description
EN	1	I	Active high input. Driving EN low immediately makes OUT go low, independent of V_{SENSE}. With V_{SENSE} already above V_{IT+}, drive EN high to make OUT go high after the capacitor-adjust delay time.
GND	2		Ground pin.
SENSE	3	I	This pin is connected to the voltage that is monitored with the use of an external resistor. The output asserts after the capacitor-adjustable delay time when VSENSE rises above 0.5V and EN is asserted. The output de-asserts after a minimal propagation delay (16μs) when VSENSE falls below V_{IT+} - V_{HYS}.
OUT	4	O	OUT is an open drain output that is immediately driven low after V_{SENSE} falls below (V_{IT+} - V_{HYS}) or the EN input is low. OUT goes high after the capacitor-adjustable delay time when V_{SENSE} is greater than V_{IT+} and the EN pin is high. The open drain output can be pulled up to 18V independent of VCC; a pull-up resistor is required for proper operation.
CT	5	I	Capacitor-adjustable delay. The CT pin offers a user-adjustable delay time. Connecting this pin to a ground-referenced capacitor sets the delay time for SENSE rising above 0.5V to OUT asserting. $t_{pd(r)}(s) = [C_{CT}(\mu F) \times 4] + 40\mu s$
VCC	6	I	Supply voltage input. Connect a 1.7V to 6.5V supply to VCC to power the device. It is recommended to place a 0.1μF ceramic capacitor close to this pin.

Block Diagram

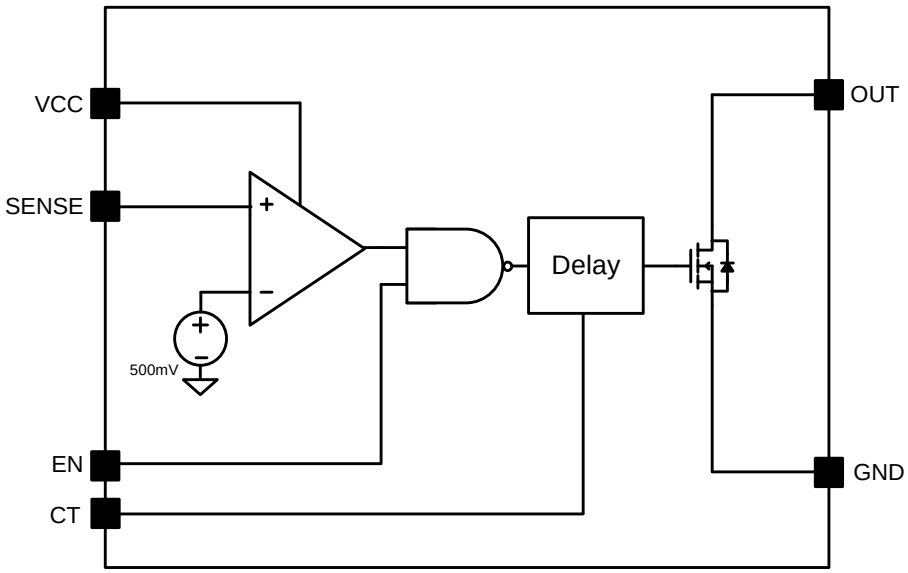


Figure 2. Block Diagram

Absolute Maximum Ratings

Parameter (Note 1)	Min	Max	Unit
VCC, EN, SENSE	-0.3	7	V
CT	-0.3	VCC + 0.3	
OUT (Open Drain)	-0.3	20	
OUT Current	-10	10	mA
Lead Temperature (Soldering, 10s)		260	°C
Junction Temperature, Operating	-40	125	
Storage Temperature	-65	150	

Thermal Information

Parameter (Note 2)	Typ	Unit
θ_{JA} Junction-to-Ambient Thermal Resistance	293.8	°C/W
θ_{JC} Junction-to-Case Thermal Resistance	165.1	
P_D Power Dissipation T_A = 25°C	0.34	W

Recommended Operating Conditions

Parameter (Note 3)	Min	Max	Unit
VCC	1.7	6.5	V
CT, EN, SENSE	0	6.5	
OUT (Open Drain)	0	18	
OUT Current	0.0003	1	mA

Electrical Characteristics

Over the operating temperature range of T_J = -40°C to 125°C, and 1.7V < V_{CC} < 6.5V. Typical values are at T_J = 25°C and V_{CC} = 3.3V. Unless otherwise noted. The values are guaranteed by test, design or statistical correlation.

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Input Voltage Range	V_{CC}	T_J= -40°C to 125°C	1.7		6.5	V
Power On Reset Voltage	V_{POR}	V_{OL}(max) =0.2V, I_{OUT} =15μA (Note 4)		0.72		V
Supply Current (into VCC pin)	I_{CC}	V_{CC}=3.3V, T_A=25°C, No load		9	12	μA
		V_{CC}=3.3V, T_A=125°C, No load		12	14	μA
		V_{CC}=6.5V, T_A=25°C, No load		11	13.5	μA
		V_{CC}=6.5V, T_A=125°C, No load		14	16	μA
Positive-Going Input Threshold Voltage	V_{IT+}	V_{SENSE} rising, -40°C <T_J < 125°C	0.495	0.5	0.505	V
Hysteresis Voltage	V_{HYS}	V_{SENSE} falling		5		mV
SENSE Input Current	I_{SENSE}	V_{SENSE} = 0V to V_{CC} (Note 5)	-15		15	nA
CT Pin Charge Current	I_{CT}		260	310	360	nA
CT Pin Comparator Threshold Voltage	V_{CT}		1.18	1.238	1.299	V
CT Pin Down Resistance	R_{CT}			200		Ω
Low-Level Input Voltage	V_{IL}				0.4	V
High-Level Input Voltage	V_{IH}		1.4			V
Undervoltage Lockout	V_{UVLO}	V_{CC} falling, (Note 6)	1.3		1.7	V
EN Leakage		EN = V_{CC} or GND	-100		100	nA
Low-Level Output Voltage	V_{OL}	V_{CC} ≥ 1.2V, I_{SINK} = 90μA			0.3	V
		V_{CC} ≥ 2.25V, I_{SINK} = 0.5mA			0.3	V
		V_{CC} ≥ 4.5V, I_{SINK} = 1mA			0.4	V
Open-Drain Output Leakage Current	$I_{LKG(OD)}$	V_{OUT} high impedance = 18V		20		nA

Timing Requirements

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
SENSE (Rising) to OUT Propagation Delay	$t_{PD(r)}$	V_{SENSE} rising, C_{CT} = open		40		μs
		V_{SESNE} rising, C_{CT} = 0.047μF		190		ms
Sense (Falling) to OUT Propagation Delay	$t_{PD(f)}$	V_{SENSE} falling		16		μs
Start-Up Delay		(Note 7)		50		μs
EN Pin Minimum Pulse Duration	t_W		1			μs
EN Glitch Rejection	t_{EN_GLH}			100		ns
EN to OUT Delay Time (Output Disable)	t_{d_off}	EN de-asserted to output de-asserted		200		ns
EN to VOUT Delay Time	t_{d_ct}	EN asserted to output asserted delay, C_{CT}=open		20		μs
		EN asserted to output asserted delay, C_{CT}= 0.047μF		190		ms

Note 1: Stresses beyond the “Absolute Maximum Ratings” may cause permanent damage to the device. These are stress ratings only. Functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Note 2: θ_{JA} is measured in the natural convection at T_A = 25°C on a low effective single-layer thermal conductivity test board of JEDEC 51-3 thermal measurement standard.

Note 3: The device is not guaranteed to function outside its operating conditions

Note 4: The lowest supply voltage (VCC) at which output is active (OUT is low); t_{r_VCC} > 15 μs/V. Below V_{POR}, the output cannot be determined.

Note 5: Specified by design.

Note 6: When VCC falls below the UVLO threshold, the output de-asserts (OUT goes low). Below V(POR), the output cannot be determined

Note 7: During power on, V_{CC} must exceed 1.7V for at least 50μs (plus propagation delay time, $t_{PD(r)}$) before the output is in the correct state.

Timing Sequence:

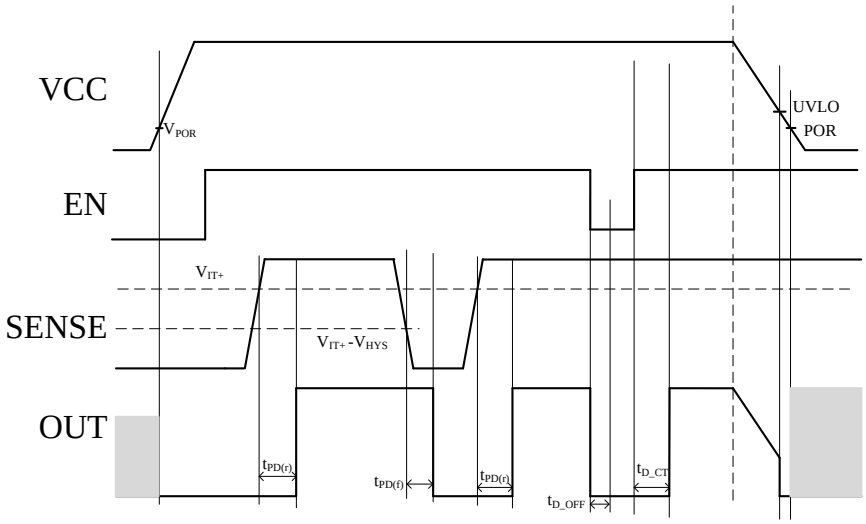
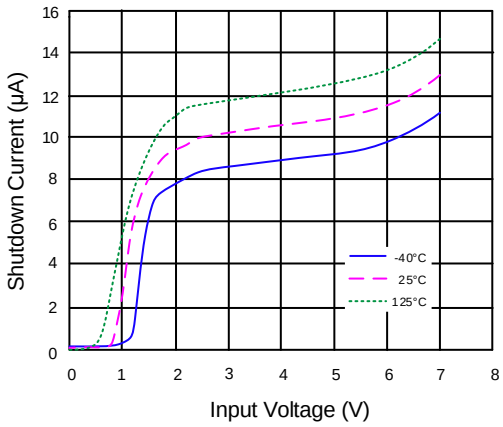


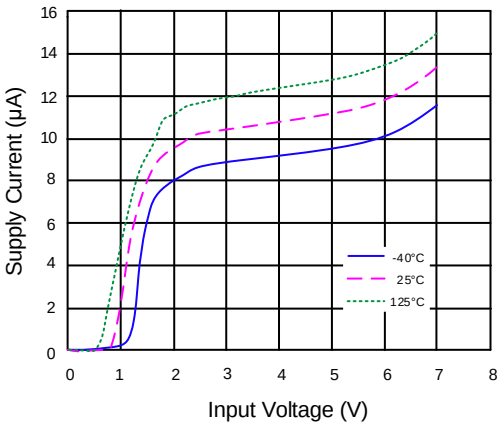
Figure 3. SY28637E Timing Sequence

Typical Performance Characteristics

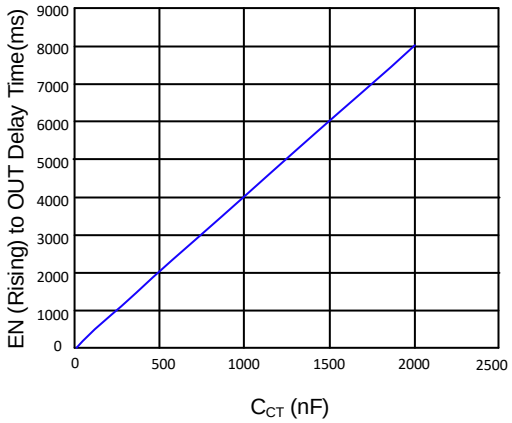
Shutdown Current vs. Input Voltage
(EN=0V, SENSE=0V, C_{IN}=1μF, CT=Null)



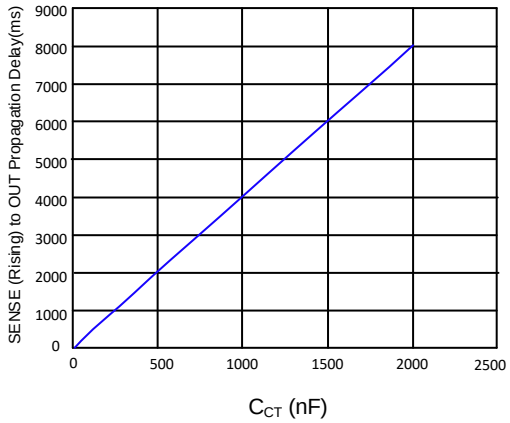
Supply Current vs. Input Voltage
(EN=V_{CC}, SENSE=0.6V, C_{IN}=1μF, CT=Null)



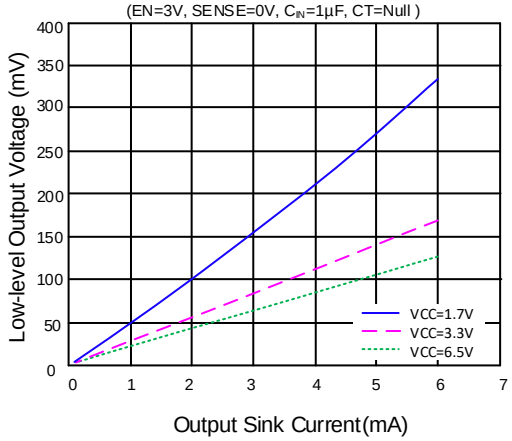
EN (Rising) to OUT Delay Time vs. C_{CT}
(V_{CC}=3.3V, EN=3V, SENSE=0.6V, C_{IN}=1μF, Null Load)



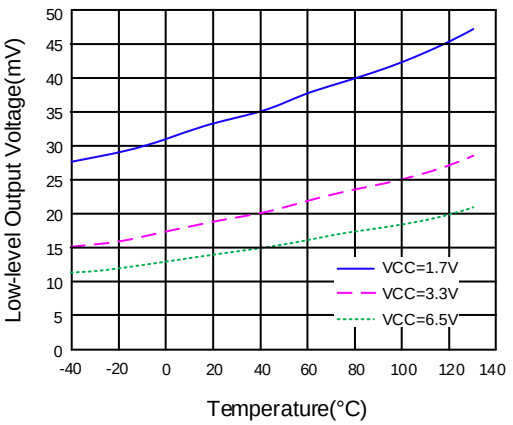
SENSE (Rising) to OUT Propagation Delay vs. C_{CT}
(V_{CC}=3.3V, EN=3V, SENSE=0.6V, C_{IN}=1μF, Null Load)



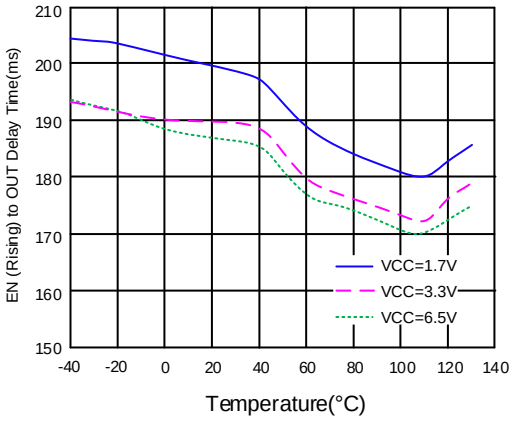
Low-level Output Voltage vs. Output Sink Current
(EN=3V, SENSE=0V, C_{IN}=1μF, CT=Null)



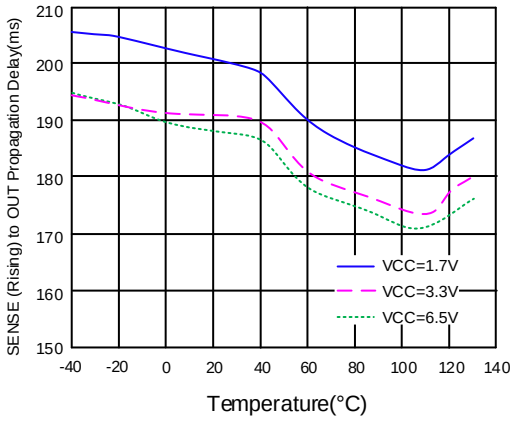
Low-level Output Voltage vs. Temperature
(EN=3V, SENSE=0V, C_{IN}=1μF, CT Null, Output Sink Current=1mA)



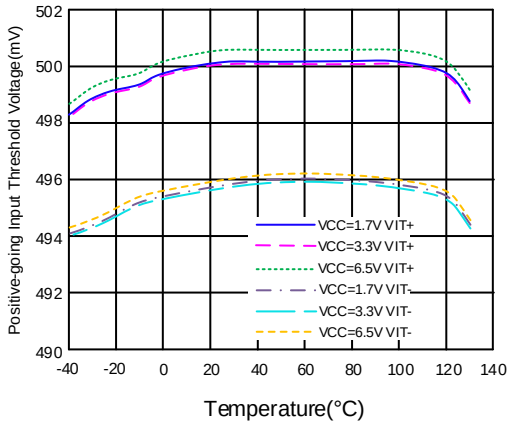
EN (Rising) to OUT Delay Time vs. Temperature
(EN=3V, SENSE=0V to 0.6V, C_{IN}=1µF, CT=47nF,
Output Sink Current=1mA)



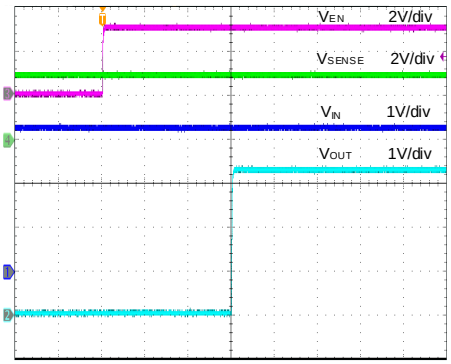
SENSE (Rising) to OUT Propagation Delay vs. Temperature
(EN=3V, SENSE=0V to 0.6V, C_{IN}=1µF, CT=47nF,
Output Sink Current=1mA)



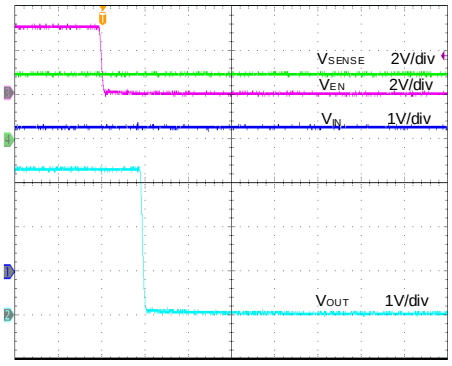
Positive-going Input Threshold Voltage vs. Temperature
(EN=3V C_{IN}=1uF CT=Null)



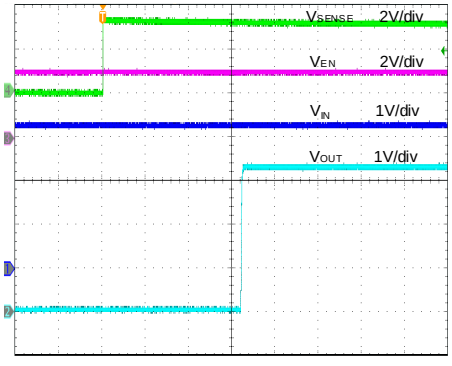
Startup from Enable
(V_{CC}=3.3V, EN=0V to 3V, C_{IN}=1µF, SENSE=3V, CT=Null)



Shutdown from Enable
(V_{CC}=3.3V, EN=3V to 0V, C_{IN}=1µF, SENSE=3V, CT=Null)

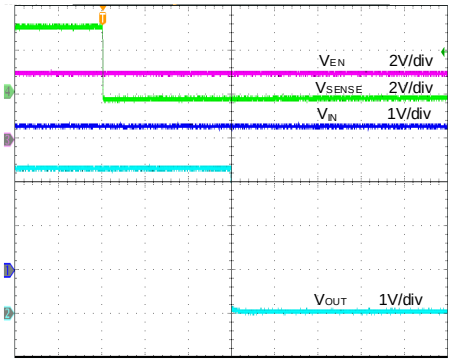


Startup from SENSE
(V_{CC}=3.3V, EN=3V, SENSE=0V to 3V, C_{IN}=1µF, CT=Null)



Shutdown from SENSE

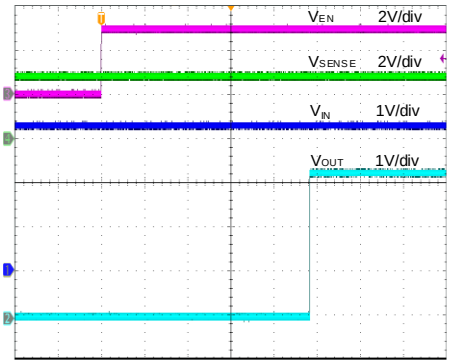
(V_{CC}=3.3V, EN=3V, SENSE=3V to 0V, C_{IN}=1μF, CT=Null)



Time (2μs/div)

Startup from Enable

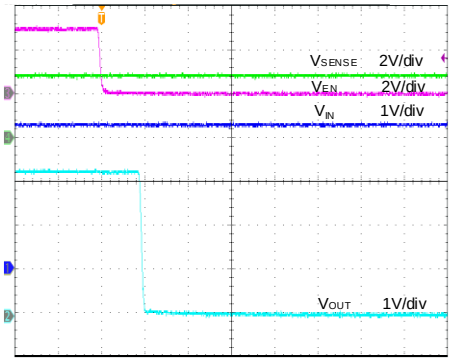
(V_{CC}=3.3V, EN=0V to 3V, C_{IN}=1μF, SENSE=3V, CT=47nF)



Time (40ms/div)

Shutdown from Enable

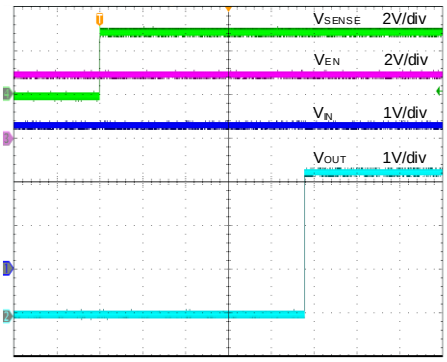
(V_{CC}=3.3V, EN=3V to 0V, C_{IN}=1μF, SENSE=3V, CT=47nF)



Time (200ns/div)

Startup from SENSE

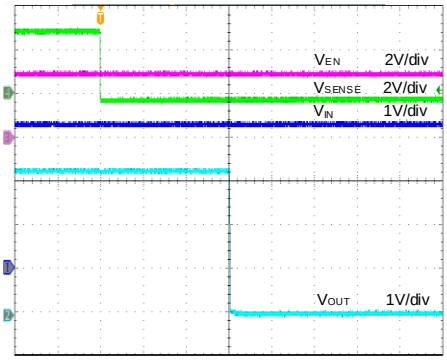
(V_{CC}=3.3V, EN=3V, SENSE=0V to 3V, C_{IN}=1μF, CT=47nF)



Time (40ms/div)

Shutdown from SENSE

(V_{CC}=3.3V, EN=3V, SENSE=3V to 0V, C_{IN}=1μF, CT=47nF)



Time (2μs/div)

Application Information

The SY28637E is a compact supervisory circuit that monitors voltages greater than 500mV with 1% threshold accuracy and offers an adjustable delay time using an external capacitor. It features a logic enable pin to control the power on and off for the output.

Operating within a voltage range of 1.7V to 6.5V, the SY28637E has a typical quiescent current of 9μA and an open-drain output rated at 18V. This device is available in an ultra-small DFN package and is fully specified for operation over a temperature range of TJ=-40°C to 125°C.

Table 1. SY28637EDTD Truth Table

CONDITIONS		OUTPUT	STATUS
ENABLE = high	SENSE < VIT+	OUT = low	Output not asserted
ENABLE = low	SENSE < VIT+	OUT = low	Output not asserted
ENABLE = low	SENSE > VIT+	OUT = low	Output not asserted
ENABLE = high	SENSE > VIT+	OUT = high	Output asserted after delay

SENSE Input Pin:

The SENSE input pin is designed to monitor system voltages greater than 0.5V. When the voltage on this pin reaches the threshold voltage (VIT+), and the ENABLE input is high, the output will be asserted after a delay set by a capacitor-adjustable timer. The output is de-asserted when the voltage at the SENSE pin falls below (VIT+ - Vhys). The comparator features built-in hysteresis to ensure smooth transitions between output assertions and de-assertions. While not typically necessary, a 1nF to 10nF bypass capacitor at the SENSE input is recommended for high noise environments, in order to mitigate sensitivity to transients and layout parasitics. The desired threshold voltage can be calculated using the following equation:

$V_{TARGET}=(1+R_1/R_2)\times 0.5(V)$ (1)

CT Output Delay Time:

The delay time can be programmed by adding an external capacitor between the CT pin and the ground. If the CT pin is floating, the device will use the internally set delay of 40μs. If required, the delay time can be extended to a value determined by the following equation:

$tpd(r)\ (s) = [C_{CT}(\mu F)\times 4] + 40\ \mu s$ (2)

The reset delay time is determined by the duration required for the on-chip, precision 310nA current source to charge an external capacitor to 1.24V. The internal current source is enabled when the voltage on the SENSE pin exceeds VIT+ and ENABLE is set high, initiating the charging of the external capacitor. Once the voltage across a capacitor reaches 1.24V, the OUT signal will be asserted. The use of a good dielectric ceramic capacitor is recommended for most applications. Note that stray capacitance around this pin could introduce errors when compared with the calculated reset delay time.

Output Pin (OUT):

In a typical application, the output is connected to a reset/enable input of the processor (MCU, DSP, CPU, FPGA, ASIC, etc.) or to the enable pin of a voltage regulator.

The SY28637E features an open-drain output. A pull-up resistor must be used to ensure proper interfacing between the OUT pin and the circuit it controls. By connecting the pull-up resistor to an adequate voltage rail, OUT can be connected to other devices using different interface voltage levels. The outputs can be pulled up to 18V independent of the supply voltage (VCC). To ensure proper voltage levels, some thought should be given to choosing the correct pull-up resistor value. The ability to sink current is determined by the supply voltage; as an example, if VCC = 5V and the desired output pull-up rails is 18 V, then to obtain a sink current of 1 mA or less (as mentioned in the Electrical Characteristics section), the pull-up resistor value should be greater than 18 kΩ. Multiple devices can be used to monitor different voltage levels in a system and their outputs can be OR-wired, to create a single logic control signal.

Enable Function:

An external logic signal from processors can control the enable input of the SY28637E, turning the output on or off. The device features an active-high enable input (ENABLE). When ENABLE is driven high, the OUT pin will be in high-impedance state. The threshold levels for ENABLE are 0.4V (maximum) when low, and 1.4V (minimum) when high, allowing it to be driven by a system supply of 1.5V or higher.

For the SY28637E, with VSENSE greater than VIT+, driving ENABLE high causes OUT to go high-impedance, but only after the lapse of a capacitor-adjustable delay time.

PCB Layout Guide:

For the best performance of the SY28637E, the following guidelines must be strictly followed:

1. Keep all power traces as short and wide as possible and use at least 1-ounce copper for all power traces.
2. Place a ground plane under all circuitry to lower both resistance and inductance and improve DC and transient performance.
3. Place the VCC decoupling capacitor close to the device.
4. Avoid using long traces for the VCC supply node. The VCC capacitor (CVCC), along with parasitic inductance from the supply to the capacitor, can form an LC tank and create ringing with peak voltages above the maximum VCC voltage.
5. Input and output capacitors should be placed close to the device and connected to the ground plane to reduce noise coupling.

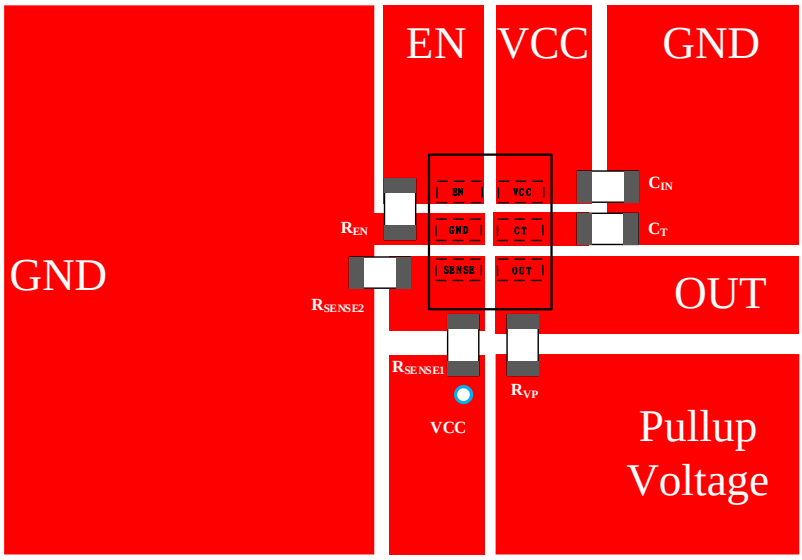
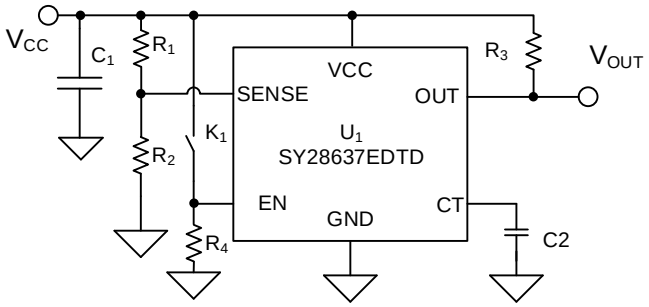


Figure 4. PCB Layout Suggestion

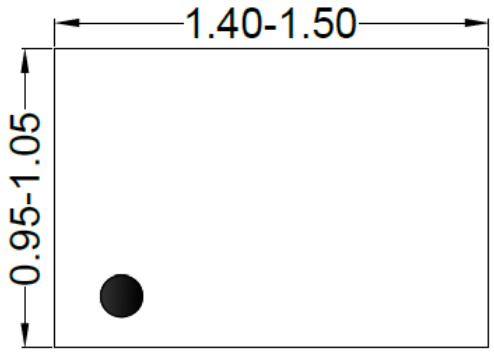
Schematic



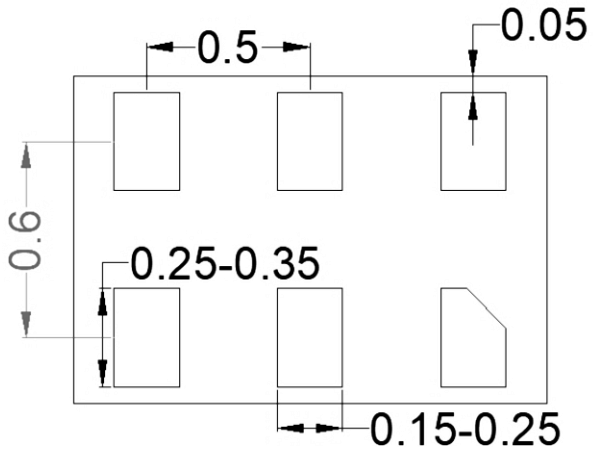
BOM List

Designator	Description	Part Number	Manufacturer
C_1	1μF/50V, 0603, X5R	GRM188R61H105K	Murata
C_2	47nF/25V,0603,X5R	GRM188R71H473K	Murata
R_1	500kΩ, 0603		
R_2	100kΩ, 0603		
R_3	10kΩ, 0603		
R_4	1MΩ, 0603		

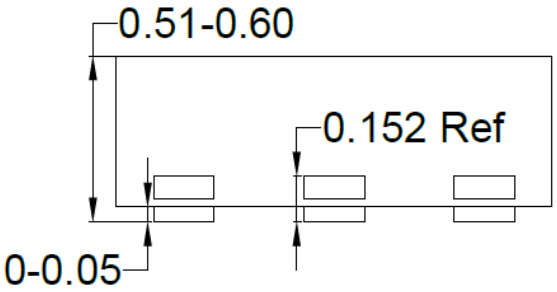
DFN1.45×1-6 Package Outline Drawing



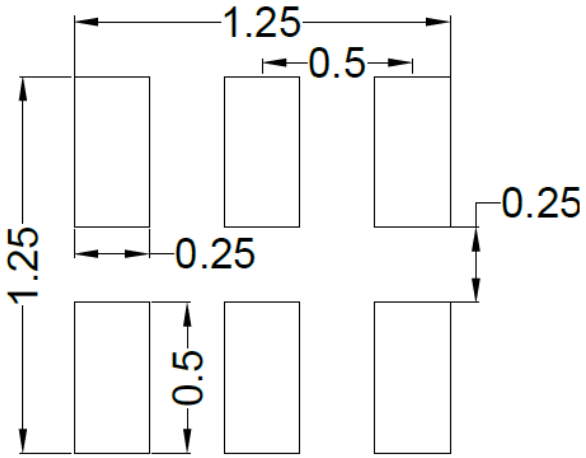
Top View



Bottom View



Side View

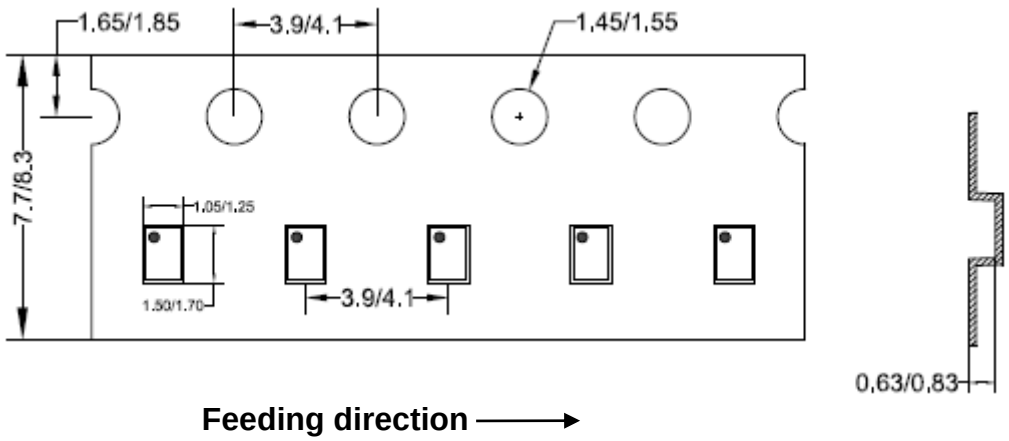


Recommended PCB Layout
(Only for Reference)

Note: All dimensions are in millimeters and exclude mold flash and metal burr.

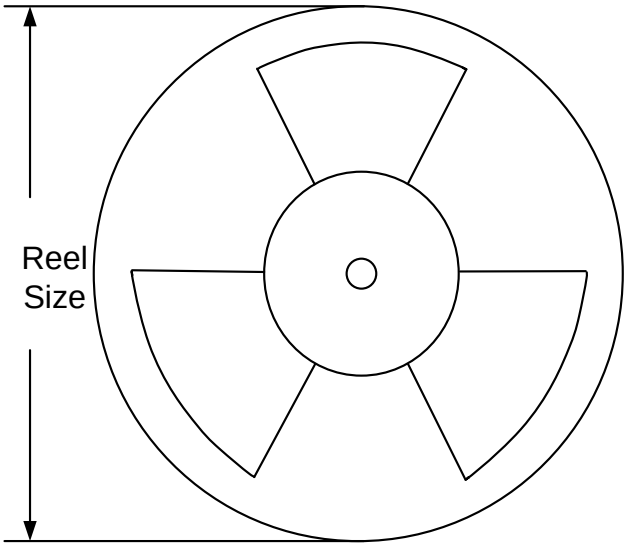
Tape and Reel Information

Tape Dimensions and Pin1 Orientation



Feeding direction ⟶

Carrier Tape & Reel Specification for Packages



Package types	Tape width (mm)	Pocket pitch (mm)	Reel size (Inch)	Trailer length (mm)	Leader length (mm)	Qty per reel
DFN1.45×1	**8**	**4**	**7"**	**400**	**160**	**3000**

Revision History

The revision history provided is for informational purpose only and is believed to be accurate, however, not warrantied. Please make sure that you have the latest revision.

Date	Revision	Change
July 09, 2025	Revision 1.0A	1. The logic gate in the Block Diagram changed from AND gate to NAND gate (Page 3) 2. Language improvements for clarity.
Oct.09, 2023	Revision 1.0	Initial Production Release
Oct.09, 2022	Revision 0.9	Initial Release

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